Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
1752-21.1				Form Type Distribute								
Supplier	Information											
Company name* Company unique ID				Unique ID Authority				Response Date*				
On Semiconductor					2020-05-27							
Contact Name Title - Contact			tact			Phone - Contact	*		Email - Contact*			
Product-Env-Stewards Product Enviro Comp			viro Compliance		NA				Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative					Phone - Representative*			Email - Representative*				
Product-H	Env-Stewards	Product E	Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com			
	Requester Item Number Mfr Item Number Mfr Item Nam		Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type
		AR0521SR2C09SUR 5MP 1/2 CIS SO A0-DR		1		2020-05-27		TA1		291.23	mg	Each
Manufacturing Process Information												
	Terminal Plating / Grid Array Material Terminal Base Alloy J-S		J-STD-020 MSL	Rating	Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycle							
	Precious metal (e.g. Ag,Au, NiPdAuSn)	ı) (no CU Alloy	CU Alloy 4			260	C	30	seco	nds 3		
Comments												
For more	For more information regarding material composition please refer to page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Iability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Sta										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature Instructions: Complete all of the required fields on all pages of this form, Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the										
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the					
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the					

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	62.83	mg	Supplier	Misc.	n/a		0.2388	mg
			Supplier	Silicon (Si)	7440-21-3		61.9692	mg
			Supplier	Aluminum (Al)	7429-90-5		0.622	mg
Die Attach	2.76	mg	Supplier	Bisphenol A_Epichlorohydrin polymer	25068-38-6		1.035	mg
			Supplier	Ethylene Glycol	107-21-1		0.0276	mg
			Supplier	Sulfonium (Thiodi-4,1-phenylene)	89452-37-9		0.0828	mg
			Supplier	Modified Silicon Dioxide (SiO2)	67762-90-7		0.5796	mg
			Supplier	Formaldehyde Polymer	9003-36-5		1.035	mg
Imaging Lens	66.68	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		3.334	mg
			Supplier	Sodium Monoxide (Na2O)	1313-59-3		3.334	mg
			Supplier	Boron Trioxide (B2O3)	1303-86-2		3.334	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		3.334	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.3334	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		3.334	mg
			Supplier	Potassium Monoxide (K2O)	12136-45-7		3.334	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		46.3426	mg
Lid Attach	2.87	mg	Supplier	Bisphenol A_Epichlorohydrin polymer	25068-38-6		0.9069	mg
			Supplier	Filler (SiO2)	68909-20-6		0.1492	mg
			Supplier	Epoxy Prepolymer	n/a		0.9069	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.9069	mg
Mold Compound-Black	59.52	mg		Phenolic Resin	proprietary		8.928	mg
			Supplier	Oxirane	39817-09-9		8.928	mg
			Supplier	1,4-Butanediol Diglycidyl Ether (DGE)	2425-79-8		1.7856	mg
			Supplier	Carbon Black (C)	1333-86-4		0.5952	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		38.0928	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		1.1904	mg
Substrate and Solder Mask	96.33	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		21.3756	mg
			Supplier	Inorganic Filler of Solder Mask_Talc (Mg3Si4O10(OH)2)	14807-96-6		1.2619	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1.2716	mg
			Supplier	Acetophenone Derivative	Propriatery		1.8881	mg
			Supplier	Carbon Black (C)	1333-86-4		0.3179	mg

			Supplier	2,4-Diethyl-9H-thioxanthen-9-one (DETX)	82799-44-8	0.3179	mg
			Supplier	Solvent Naphtha (Solvent oil)	64742-94-5	3.7761	mg
			Supplier	Bismaleimide Triazine resin	Propriatery	9.633	mg
			Supplier	Copper (Cu)	7440-50-8	46.7201	mg
			Supplier	Barium Sulfate (BaSO4)	7727-43-7	9.7679	mg
Wire Bond - Au	0.24	mg	Supplier	Gold (Au)	7440-57-5	0.24	mg